

ESD144-B1-W0201

Bi-directional ESD protection device, 18 V, 0.2 pF, 0201



Product description

This Infineon ESD (electrostatic discharge) protection device has a bi-directional and symmetric I/V characteristic and excellent clamping performance.

Feature list

- ESD / transient protection according to:
 - IEC61000-4-2 (ESD): ± 18 kV (air) / ± 18 kV (contact)
 - IEC61000-4-4 (EFT): ± 2.5 kV / ± 50 A (5/50 ns)
 - IEC61000-4-5 (Surge): ± 3.5 A (8/20 μ s)
- Bi-directional maximum working voltage: $V_{WM} = \pm 18$ V
- Line capacitance: $C_L = 0.2$ pF at $f = 1$ MHz
- Clamping voltage: $V_{cl} = 12.5$ V at $I_{TLP} = 16$ A with $R_{dyn} = 0.58 \Omega$
- Very low leakage current: $I_L = 1$ nA
- Small form factor SMD size 0201, low profile (0.58 x 0.28 x 0.15 mm³)



Potential applications

- NFC, RF Antenna

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Device information

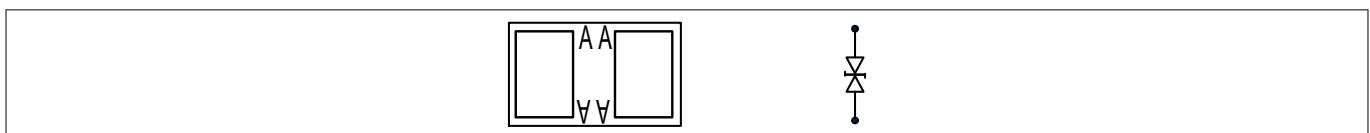


Figure 1 Pin configuration and schematic diagram

Table 1 Part information

Product name / Ordering code	Package	Pin configuration	Marking	Pieces / Reel
ESD144-B1-W0201/ESD144B1W0201E6327XTSA1	WLL-2-3	1 line, bi-directional	AA	15 k

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1 Absolute maximum ratings

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Table 2 Absolute maximum ratings at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Working voltage ¹⁾	V_{WM}	-18	+18	V	
ESD discharge voltage	V_{ESD} (contact)	-18	+18	kV	Discharge network: $R = 330 \Omega$, $C = 150 \text{ pF}$ ²⁾
	V_{ESD} (air)	-18	+18		
Peak pulse power	P_{PK}	–	21	W	Stress pulse: 8/20 μs current waveform ³⁾
Peak pulse current	I_{PP}	-3.5	+3.5	A	
Operating temperature	T_{op}	-55	+125	°C	
Storage temperature	T_{stg}	-65	+150		

Attention: *Stresses above the maximum values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings. Exceeding only one of these values may cause irreversible damage to the component.*

¹⁾ Device snaps back to a low holding voltage, refer to application note [AN525](#) for latch-up prevention.

²⁾ Based on IEC61000-4-2.

³⁾ Based on IEC61000-4-5.

2 Electrical characteristics

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Note: $T_A = 25^\circ\text{C}$, unless otherwise specified. Device is electrically symmetrical.

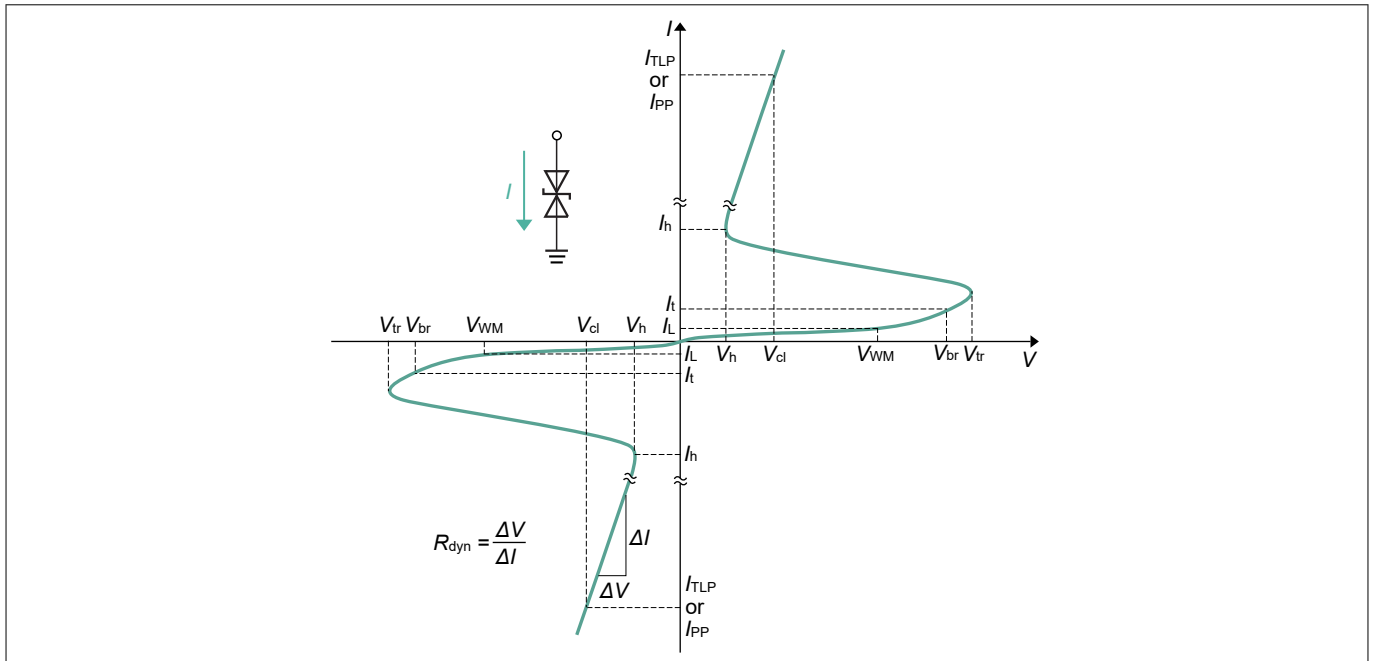


Figure 2 I/V characteristic curve

Table 3 I/V characteristic parameters

Symbol	Parameter
I_h	Holding current
I_L	Leakage current
I_{PP}	Peak pulse current, based on IEC61000-4-5
I_t	Test current
I_{TLP}	TLP current
R_{dyn}	Dynamic resistance
V_{br}	Breakdown voltage
V_{cl}	Clamping voltage
V_h	Holding voltage
V_t	Test voltage
V_{tr}	Trigger voltage
V_{WM}	Maximum working voltage

Note: For more detailed explanation of electrical parameters, refer to [1].

2 Electrical characteristics

Table 4 DC characteristics

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Breakdown voltage	V_{br}	18.5	22	28.5	V	$I_t = 1 \text{ mA}$
Holding voltage	V_h	–	1.9	–		$I = I_h$
Holding current	I_h	–	25	–	mA	$V = V_h$
Leakage current	I_L	–	1	50	nA	$V_{WM} = 18 \text{ V}$

Table 5 AC characteristics

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Line capacitance	C_L	–	0.2	0.35	pF	$V = 0 \text{ V}, f = 1 \text{ MHz}$
		–	0.19	–		$V = 0 \text{ V}, f = 2.5 \text{ GHz}$
Series inductance	L_S	–	<1	–	nH	Extracted from S-parameters

Table 6 Protection characteristics

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Clamping voltage (TLP) ^{4) 5)}	V_{cl}	–	8	–	V	$I_{TLP} = 8 \text{ A}$
		–	12.5	–		$I_{TLP} = 16 \text{ A}$
Clamping voltage (8/20 μs) ⁶⁾		–	3	–		$I_{PP} = 1 \text{ A}$
		–	5	–		$I_{PP} = 3 \text{ A}$
Dynamic resistance ⁴⁾	R_{dyn}	–	0.58	–	Ω	

⁴⁾ TLP parameters: $Z_0 = 50 \Omega$, $t_p = 100 \text{ ns}$, $t_r = 0.6 \text{ ns}$, averaging window 30-60 ns.

⁵⁾ Refer to application note AN210 [2]

⁶⁾ $t_p = 8/20 \mu\text{s}$. Stress pulse based on IEC61000-4-5.

3 Typical characteristic diagrams

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Note: $T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified.

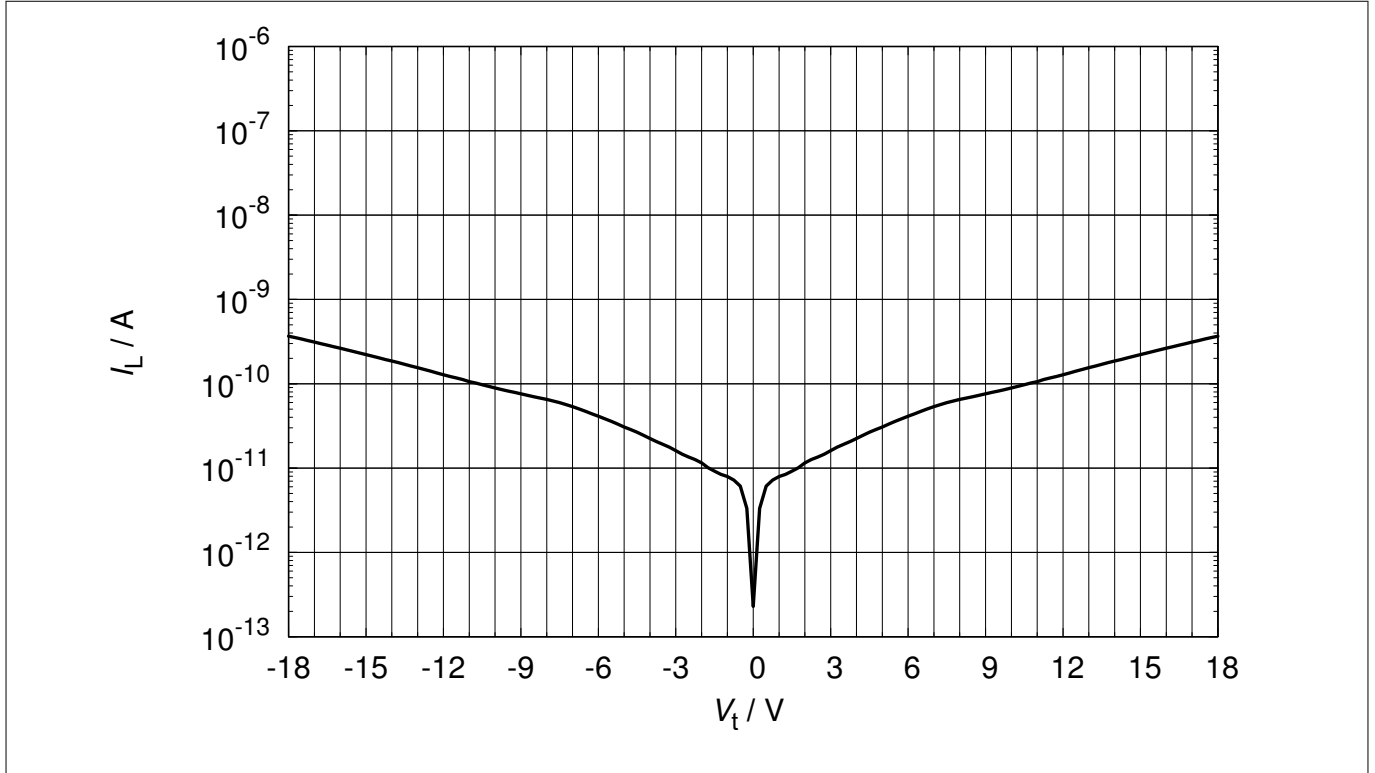


Figure 3 Leakage current: $I_L = f(V_t)$

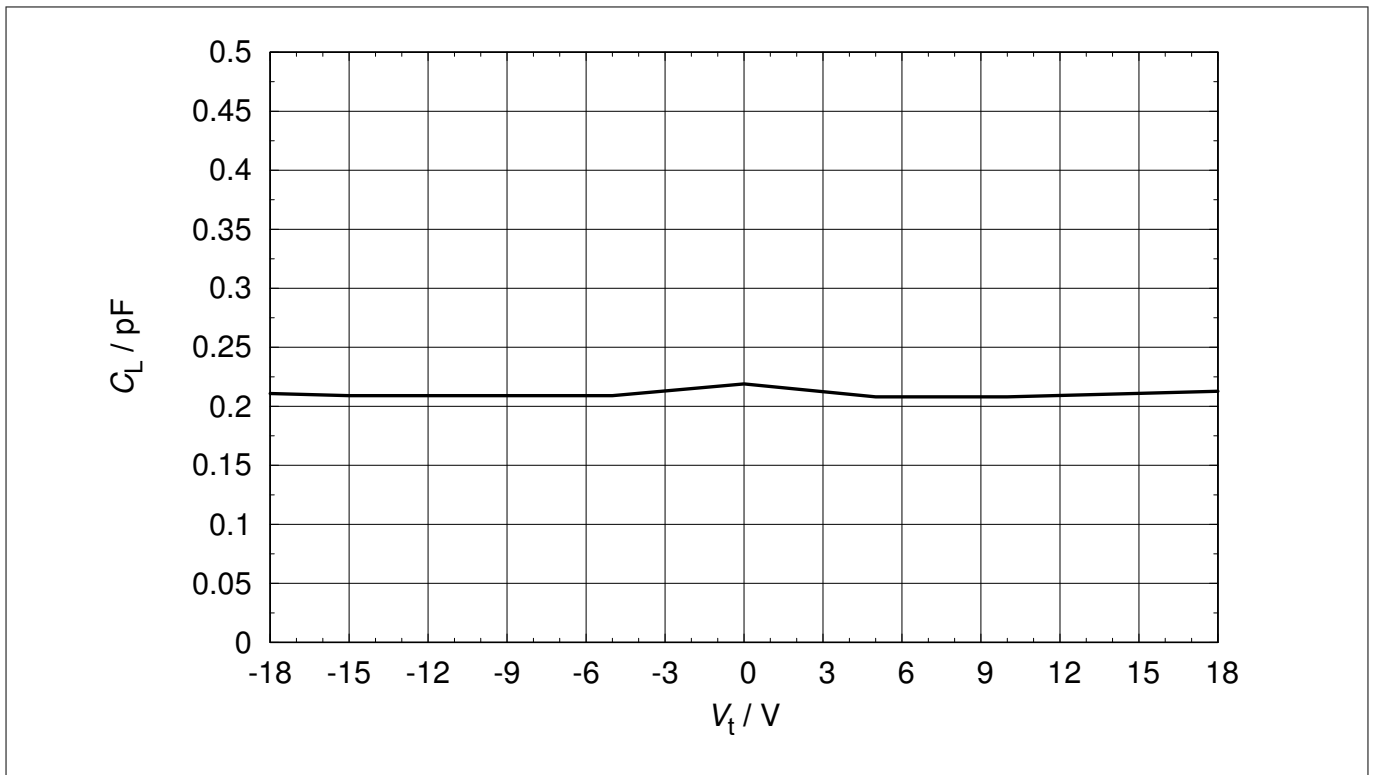


Figure 4 Line capacitance: $C_L = f(V_t)$, $f = 1\text{ MHz}$

3 Typical characteristic diagrams

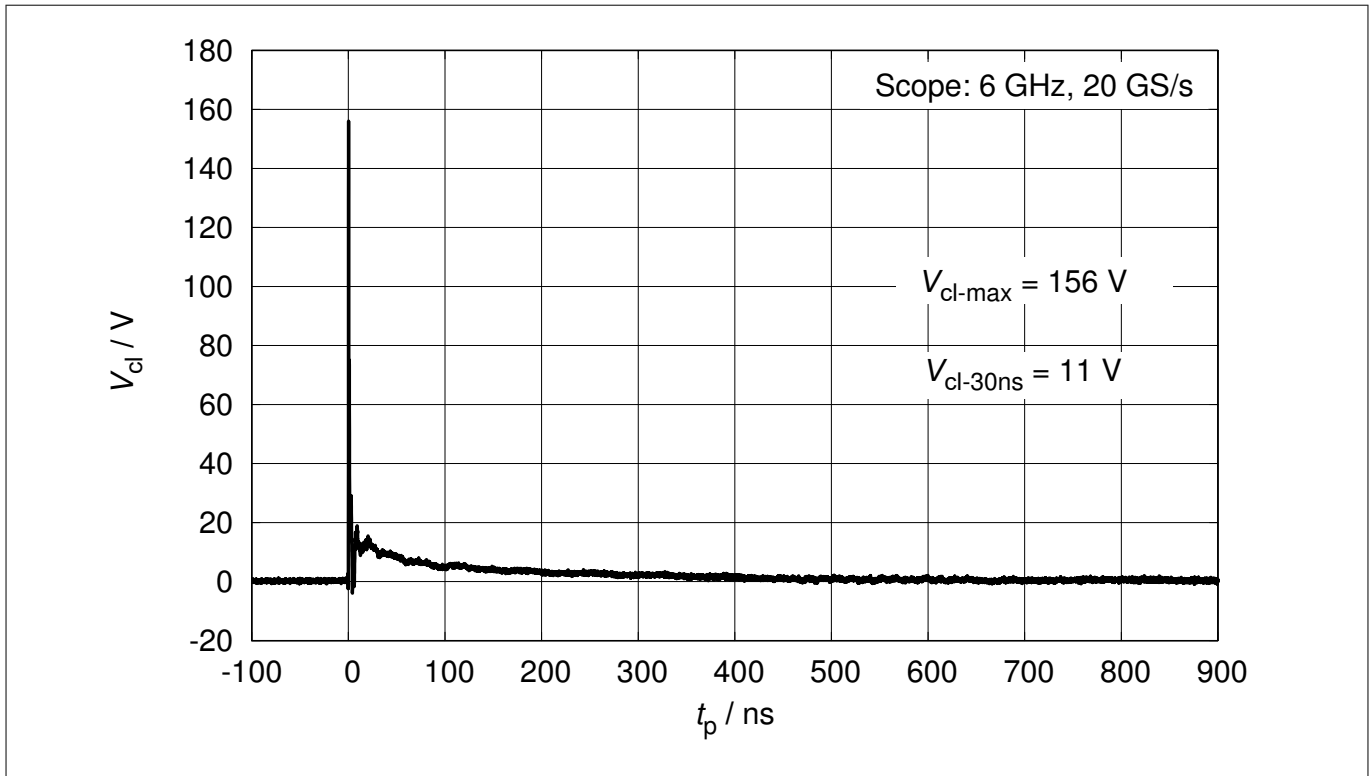


Figure 5 Clamping voltage (ESD): $V_{cl} = f(t_p)$, 8 kV positive pulse according to IEC61000-4-2

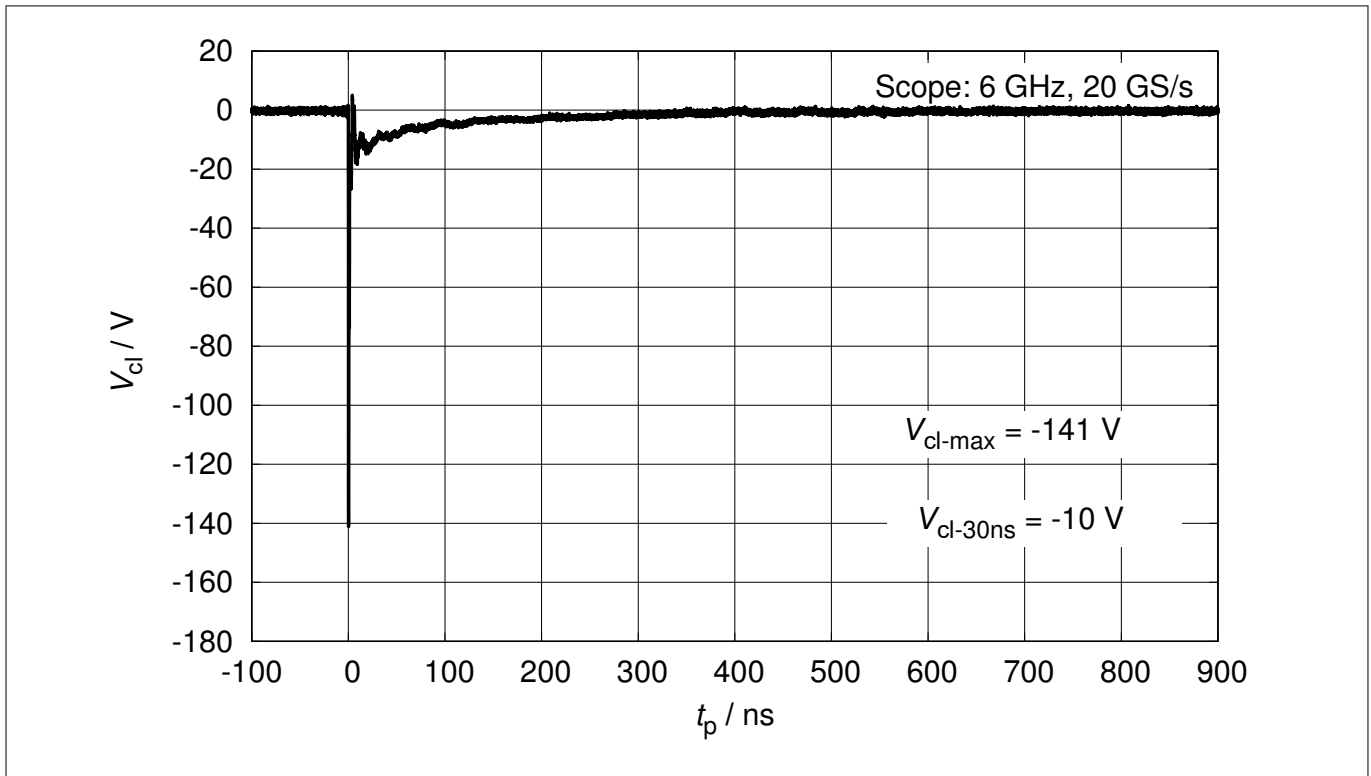


Figure 6 Clamping voltage (ESD): $V_{cl} = f(t_p)$, 8 kV negative pulse according to IEC61000-4-2

3 Typical characteristic diagrams

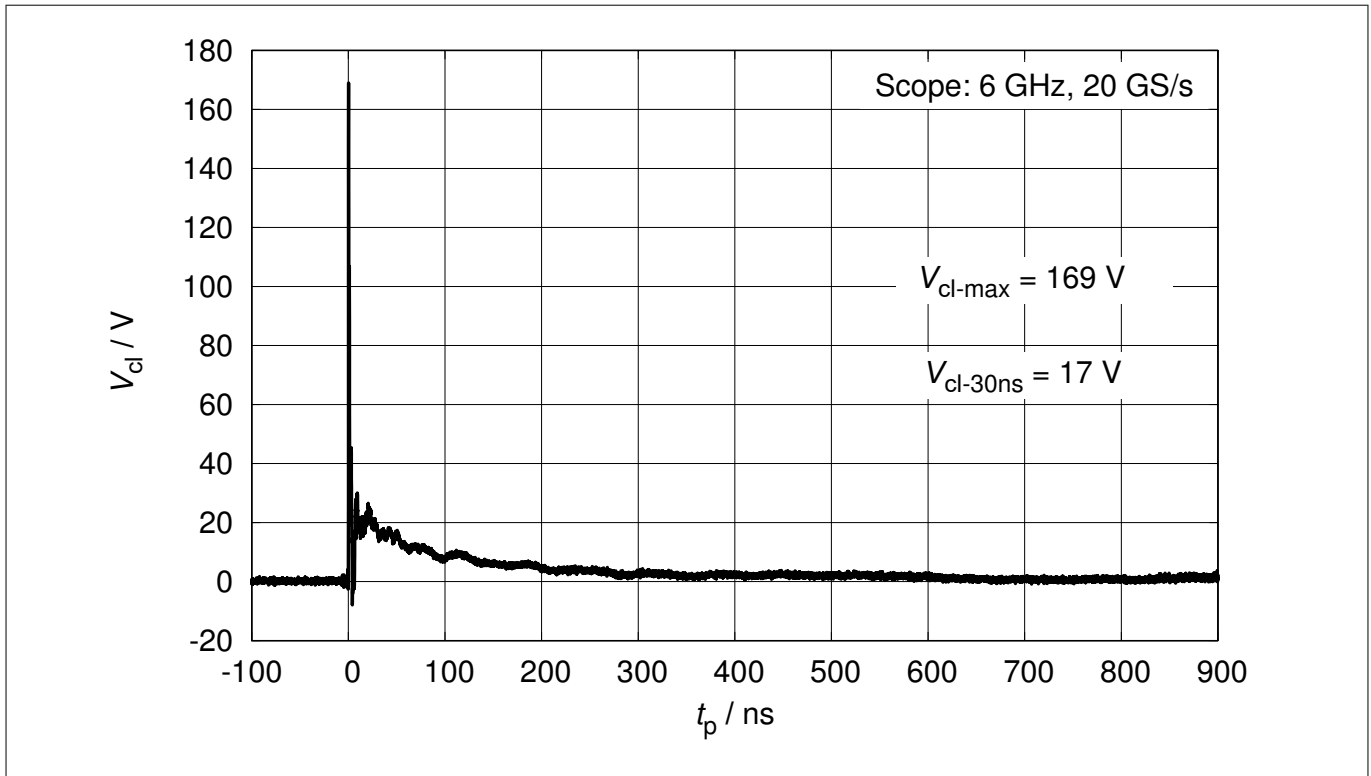


Figure 7 Clamping voltage (ESD): $V_{cl} = f(t_p)$, 15 kV positive pulse according to IEC61000-4-2

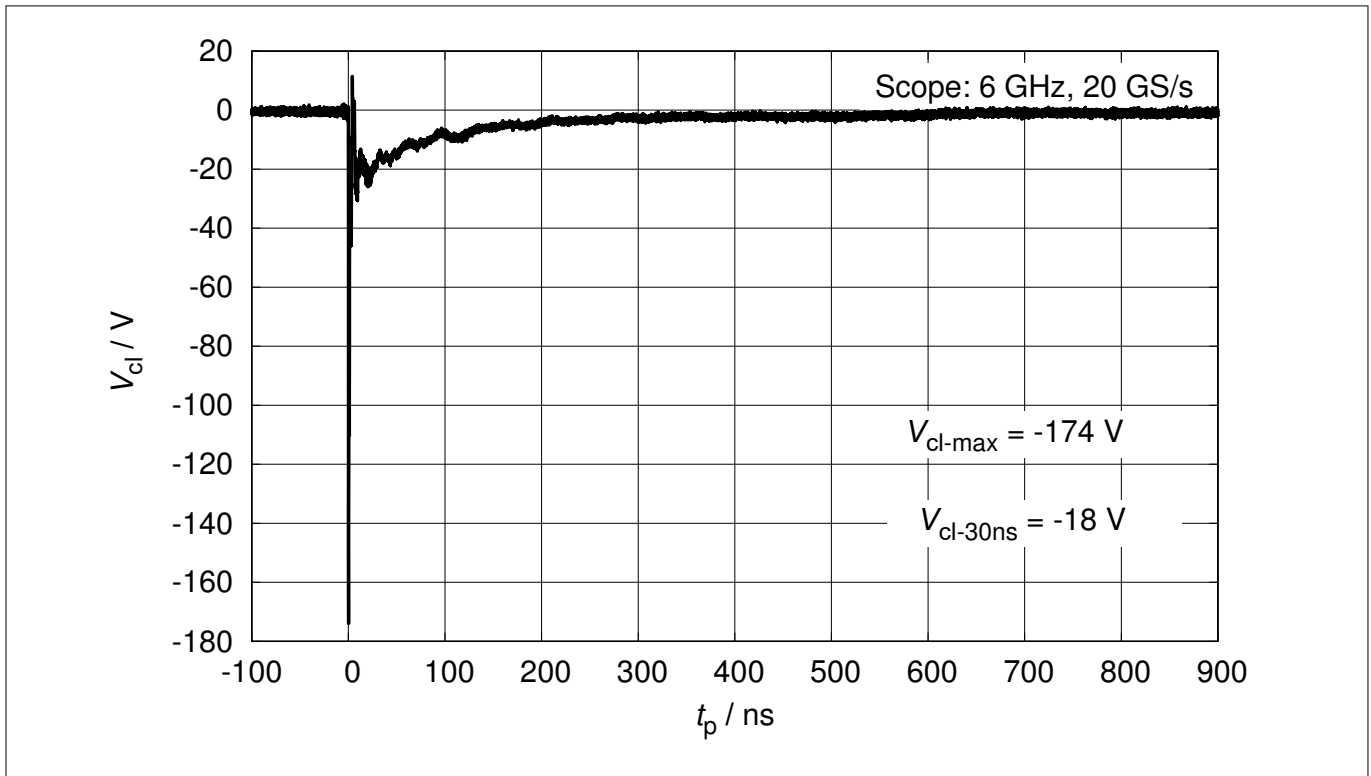


Figure 8 Clamping voltage (ESD): $V_{cl} = f(t_p)$, 15 kV negative pulse according to IEC61000-4-2

3 Typical characteristic diagrams

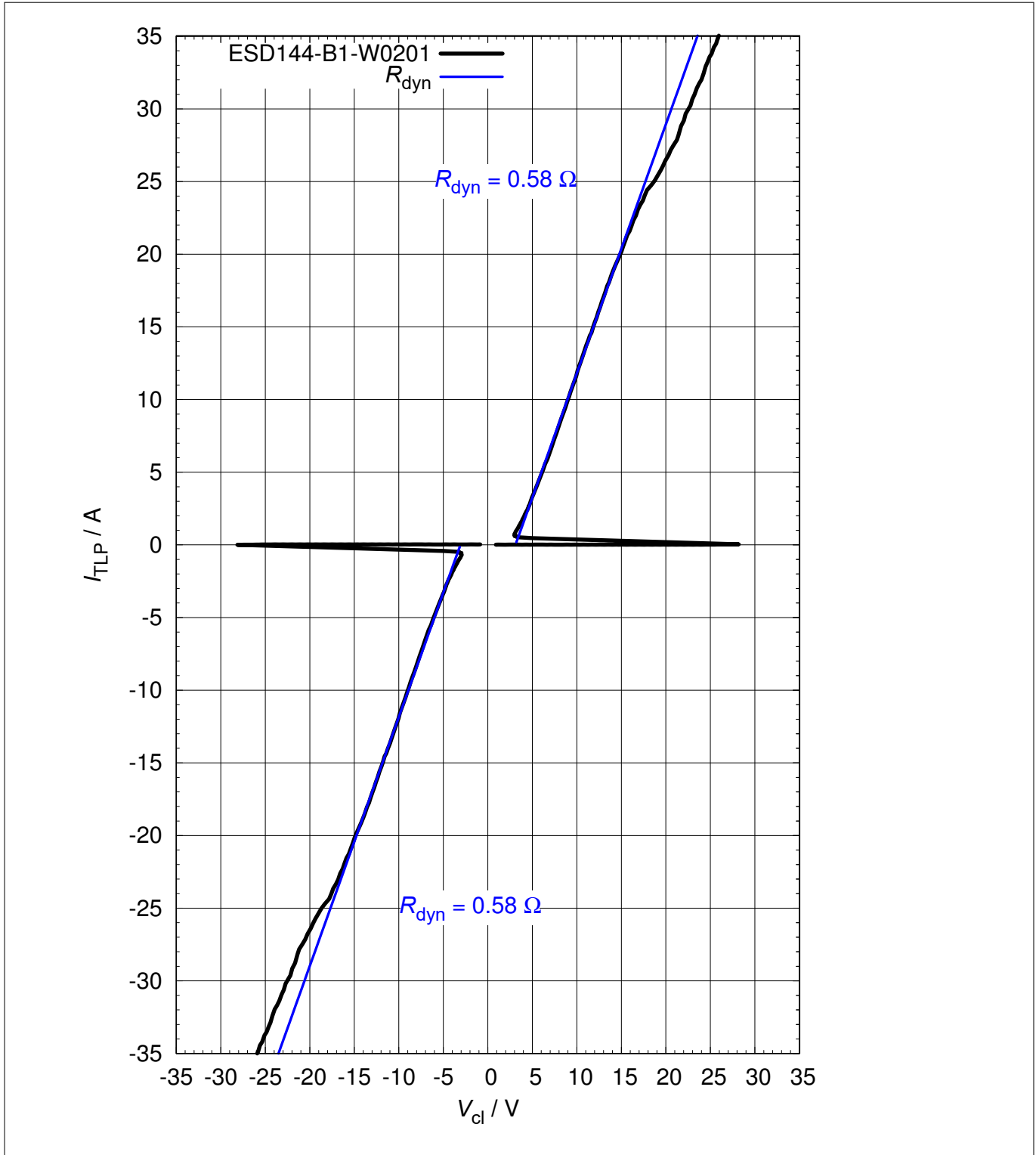


Figure 9 Clamping voltage (TLP): $I_{TLP} = f(V_{cl})$

3 Typical characteristic diagrams

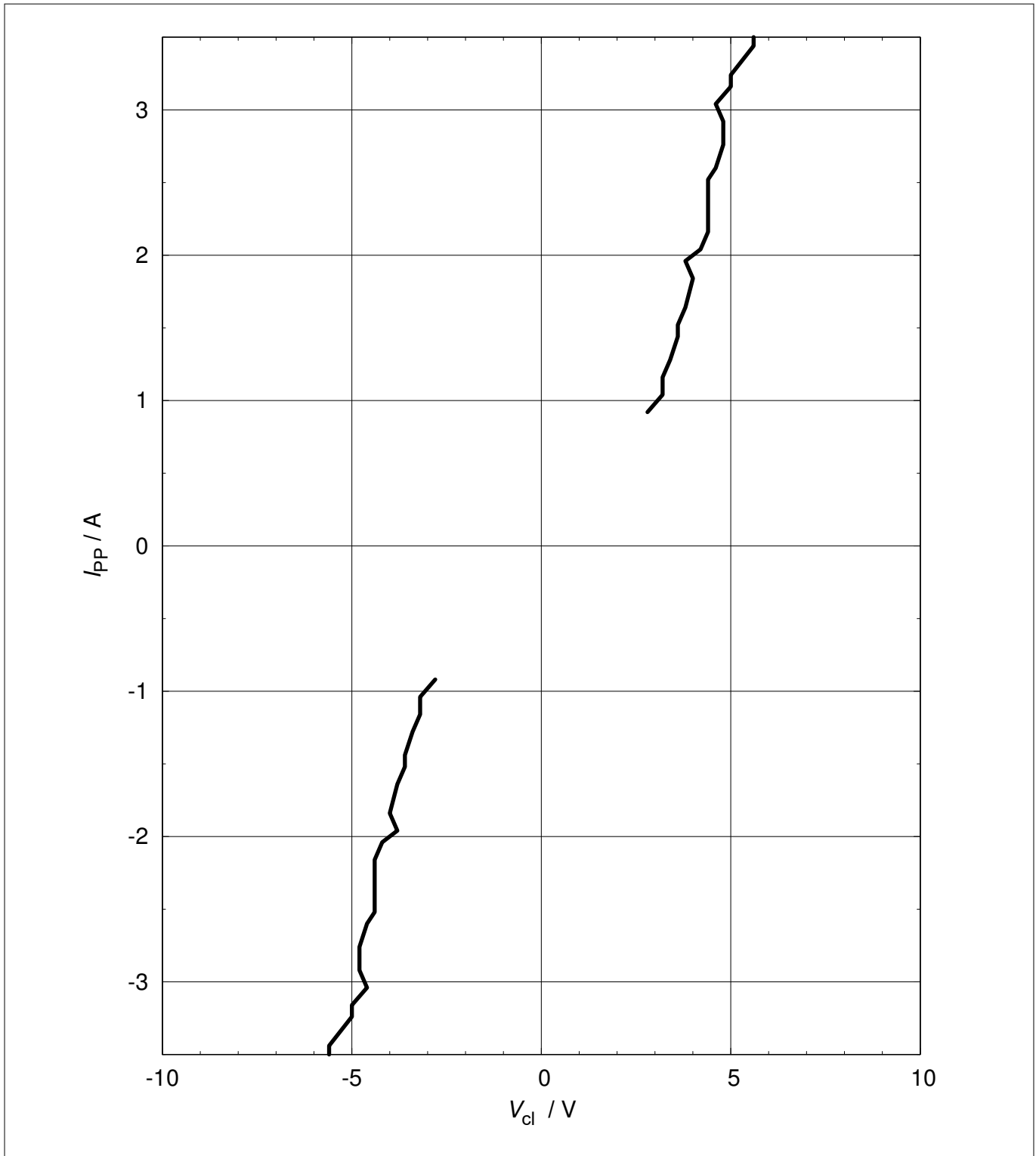


Figure 10 Clamping voltage (Surge): $I_{PP} = f(V_{Cl})$ according to IEC61000-4-5

3 Typical characteristic diagrams

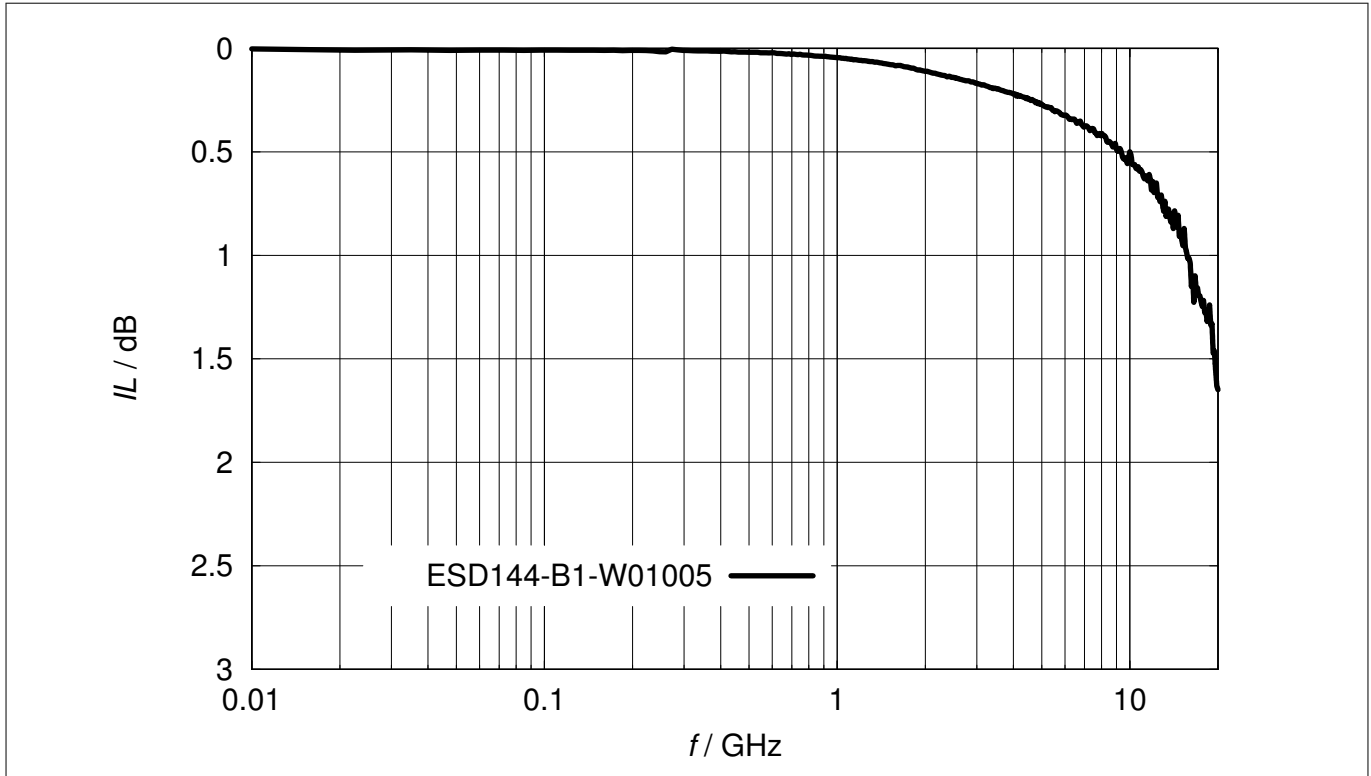


Figure 11 Insertion loss $IL = f(f)$, measured in a 50 Ω system

4 Package information WLL-2-3

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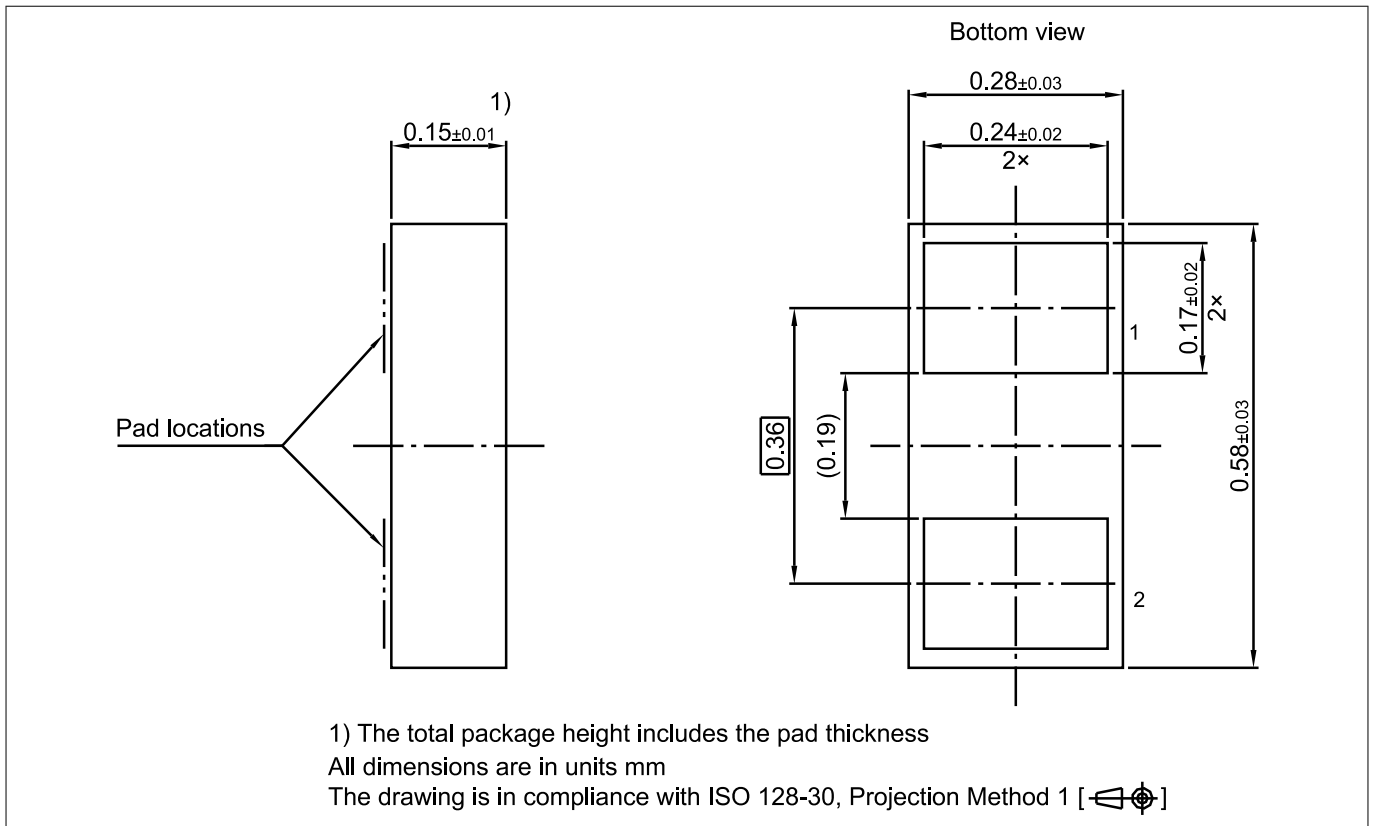


Figure 12 WLL-2-3 package

Note: For package information including footprint, packing and assembly recommendation refer to:

<https://www.infineon.com/cms/en/product/packages/SG-WLL/SG-WLL-2-3/>

5 References

5 References

[1]	Infineon AG - Understanding ESD protection device characteristics
[2]	Infineon AG - Application note AN210 : Effective ESD Protection Design at System Level Using VF-TLP Characterization Methodology

6 Revision history

Document version	Date of release	Description of changes
1.0	2017-08-14	<ul style="list-style-type: none">• First final datasheet release
2.0	2020-11-30	<ul style="list-style-type: none">• New datasheet layout• Editorial changes
2.1	2024-01-05	<ul style="list-style-type: none">• Added link to application note in Table 2

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